

## LM1458/LM1558 Dual Operational Amplifier

Check for Samples: [LM1458](#), [LM1558](#)

### FEATURES

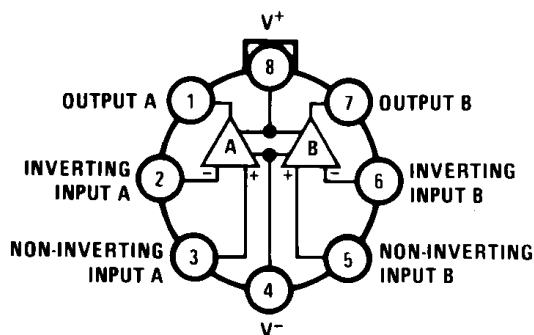
- No Frequency Compensation Required
- Short-Circuit Protection
- Wide Common-Mode and Differential Voltage Ranges
- Low-Power Consumption
- 8-Lead TO-99 and 8-Lead PDIP
- No Latch Up When Input Common Mode Range is Exceeded

### DESCRIPTION

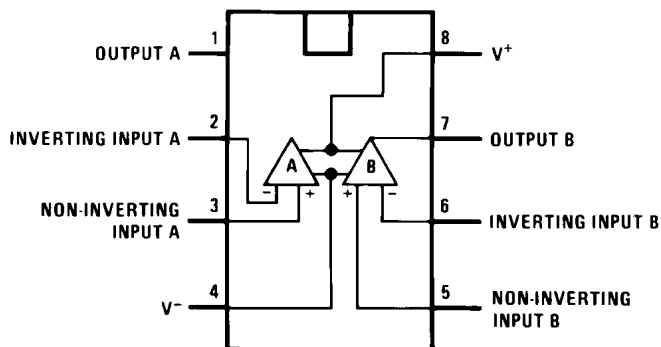
The LM1458 and the LM1558 are general purpose dual operational amplifiers. The two amplifiers share a common bias network and power supply leads. Otherwise, their operation is completely independent.

The LM1458 is identical to the LM1558 except that the LM1458 has its specifications guaranteed over the temperature range from 0°C to +70°C instead of –55°C to +125°C.

### Connection Diagram



**Figure 1. TO-99 Package  
(Top View)**  
See Package Number LMC (O-MBCY-W8)



**Figure 2. Dual-In-Line Package  
(Top View)**  
See Package Number D (R-PDSO-G8) or  
P (R-PDIP-T8)



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.



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**Absolute Maximum Ratings**<sup>(1)(2)(3)</sup>

|   |                 |
|---|-----------------|
| Supply Voltage  |                 |
| LM1558  | ±22V            |
| LM1458  | ±18V            |
| Power Dissipation <sup>(4)</sup>  |                 |
| LM1558H/LM1458H   | 500 mW          |
| LM1458N   | 400 mW          |
| Differential Input Voltage  | ±30V            |
| Input Voltage <sup>(5)</sup>  | ±15V            |
| Output Short-Circuit Duration   | Continuous      |
| Operating Temperature Range   |                 |
| LM1558  | –55°C to +125°C |
| LM1458  | 0°C to +70°C    |
| Storage Temperature Range   | –65°C to +150°C |
| Lead Temperature (Soldering, 10 sec.)   | 260°C           |
| Soldering Information   |                 |
| PDIP Package  |                 |
| Soldering (10 seconds)  | 260°C           |
| SOIC Package  |                 |
| Vapor Phase (60 seconds)  | 215°C           |
| Infrared (15 seconds)   | 220°C           |
| See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" for other methods of soldering surface mount devices. |                 |
| ESD tolerance <sup>(6)</sup>  | 300V            |

- (1) "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits.
- (2) Refer to RETS 1558V for LM1558J and LM1558H military specifications.
- (3) If Military/Aerospace specified devices are required, please contact the TI Sales Office/Distributors for availability and specifications.
- (4) The maximum junction temperature of the LM1558 is 150°C, while that of the LM1458 is 100°C. For operating at elevated temperatures, devices in the LMC package must be derated based on a thermal resistance of 150°C/W, junction to ambient or 20°C/W, junction to case. For the PDIP the device must be derated based on a thermal resistance of 187°C/W, junction to ambient.
- (5) For supply voltages less than ±15V, the absolute maximum input voltage is equal to the supply voltage.
- (6) Human body model, 1.5 kΩ in series with 100 pF.

**Electrical Characteristics**<sup>(1)</sup>

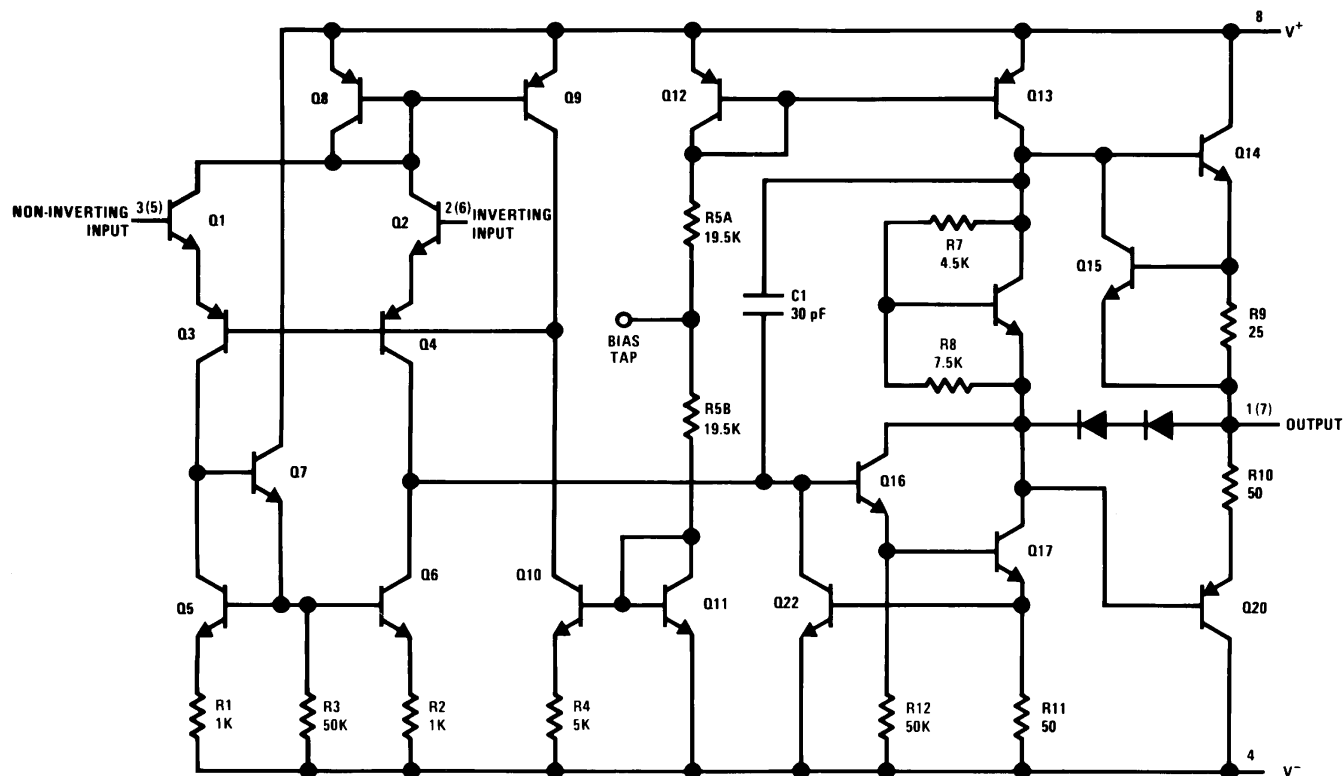
| Parameter                      | Conditions  | LM1558 |     |     | LM1458 |     |     | Units |
|--------------------------------|---|--------|-----|-----|--------|-----|-----|-------|
|                                |   | Min    | Typ | Max | Min    | Typ | Max |       |
| Input Offset Voltage           | $T_A = 25^\circ\text{C}$ , $R_S \leq 10\text{ k}\Omega$   |        | 1.0 | 5.0 |        | 1.0 | 6.0 | mV    |
| Input Offset Current           | $T_A = 25^\circ\text{C}$  |        | 80  | 200 |        | 80  | 200 | nA    |
| Input Bias Current             | $T_A = 25^\circ\text{C}$  |        | 200 | 500 |        | 200 | 500 | nA    |
| Input Resistance               | $T_A = 25^\circ\text{C}$  | 0.3    | 1.0 |     | 0.3    | 1.0 |     | MΩ    |
| Supply Current Both Amplifiers | $T_A = 25^\circ\text{C}$ , $V_S = \pm 15\text{V}$   |        | 3.0 | 5.0 |        | 3.0 | 5.6 | mA    |
| Large Signal Voltage Gain      | $T_A = 25^\circ\text{C}$ , $V_S = \pm 15\text{V}$<br>$V_{OUT} = \pm 10\text{V}$ , $R_L \geq 2\text{ k}\Omega$ | 50     | 160 |     | 20     | 160 |     | V/mV  |
| Input Offset Voltage           | $R_S \leq 10\text{ k}\Omega$  |        |     | 6.0 |        |     | 7.5 | mV    |
| Input Offset Current           |   |        |     | 500 |        |     | 300 | nA    |
| Input Bias Current             |   |        |     | 1.5 |        |     | 0.8 | μA    |
| Large Signal Voltage Gain      | $V_S = \pm 15\text{V}$ , $V_{OUT} = \pm 10\text{V}$<br>$R_L \geq \text{k}\Omega$                              | 25     |     |     | 15     |     |     | V/mV  |
| Output Voltage Swing           | $V_S = \pm 15\text{V}$ , $R_L = 10\text{ k}\Omega$<br>$R_L = 2\text{ k}\Omega$                                | ±12    | ±14 |     | ±12    | ±14 |     | V     |
|                                |   | ±10    | ±13 |     | ±10    | ±13 |     | V     |

- (1) These specifications apply for  $V_S = \pm 15\text{V}$  and  $-55^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$ , unless otherwise specified. With the LM1458, however, all specifications are limited to  $0^\circ\text{C} \leq T_A \leq 70^\circ\text{C}$  and  $V_S = \pm 15\text{V}$ .

# Electrical Characteristics <sup>(1)</sup> (continued)

| Parameter                      | Conditions                   | LM1558   |     |     | LM1458   |     |     | Units |
|--------------------------------|------------------------------|----------|-----|-----|----------|-----|-----|-------|
|                                |                              | Min      | Typ | Max | Min      | Typ | Max |       |
| Input Voltage Range            | $V_S = \pm 15V$              | $\pm 12$ |     |     | $\pm 12$ |     |     | V     |
| Common Mode Rejection Ratio    | $R_S \leq 10\text{ k}\Omega$ | 70       | 90  |     | 70       | 90  |     | dB    |
| Supply Voltage Rejection Ratio | $R_S \leq 10\text{ k}\Omega$ | 77       | 96  |     | 77       | 96  |     | dB    |

## SCHEMATIC DIAGRAM



Numbers in parentheses are pin numbers for amplifier B.

REVISION HISTORY

| Changes from Revision C (March 2013) to Revision D         | Page              |
|--|-------------------|
| • Changed layout of National Data Sheet to TI format ..... | <a href="#">3</a> |

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| LM1458 MWC       | ACTIVE        | WAFERSALE    | YS                 | 0    | 1              | Green (RoHS<br>& no Sb/Br) | Call TI                 | Level-1-NA-UNLIM     | -40 to 85    |                         | <a href="#">Samples</a> |
| LM1458M          | NRND          | SOIC         | D                  | 8    | 95             | TBD                        | Call TI                 | Call TI              | 0 to 70      | LM<br>1458M             |                         |
| LM1458M/NOPB     | ACTIVE        | SOIC         | D                  | 8    | 95             | Green (RoHS<br>& no Sb/Br) | SN                      | Level-1-260C-UNLIM   | 0 to 70      | LM<br>1458M             | <a href="#">Samples</a> |
| LM1458MX         | NRND          | SOIC         | D                  | 8    | 2500           | TBD                        | Call TI                 | Call TI              | 0 to 70      | LM<br>1458M             |                         |
| LM1458MX/NOPB    | ACTIVE        | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | SN                      | Level-1-260C-UNLIM   | 0 to 70      | LM<br>1458M             | <a href="#">Samples</a> |
| LM1458N/NOPB     | ACTIVE        | PDIP         | P                  | 8    | 40             | Green (RoHS<br>& no Sb/Br) | Call TI   SN            | Level-1-NA-UNLIM     | 0 to 70      | LM1458N                 | <a href="#">Samples</a> |
| LM1558H          | ACTIVE        | TO-99        | LMC                | 8    | 500            | TBD                        | Call TI                 | Call TI              | -55 to 125   | ( LM1558H, LM1558H<br>) | <a href="#">Samples</a> |
| LM1558H/NOPB     | ACTIVE        | TO-99        | LMC                | 8    | 500            | Green (RoHS<br>& no Sb/Br) | Call TI                 | Level-1-NA-UNLIM     | -55 to 125   | ( LM1558H, LM1558H<br>) | <a href="#">Samples</a> |
| MC1558G          | ACTIVE        | TO-99        | LMC                | 8    | 500            | TBD                        | Call TI                 | Call TI              | -55 to 125   | ( LM1558H, LM1558H<br>) | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

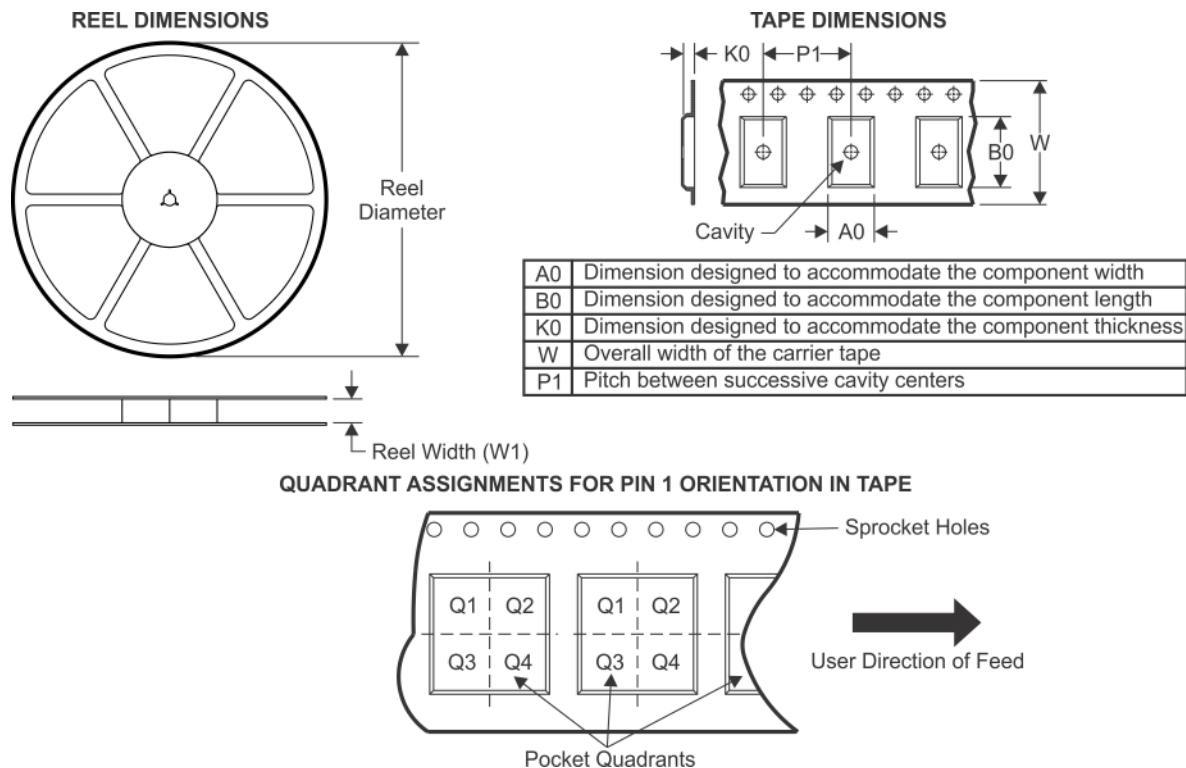
<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| LM1458MX      | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.5     | 5.4     | 2.0     | 8.0     | 12.0   | Q1            |
| LM1458MX/NOPB | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.5     | 5.4     | 2.0     | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



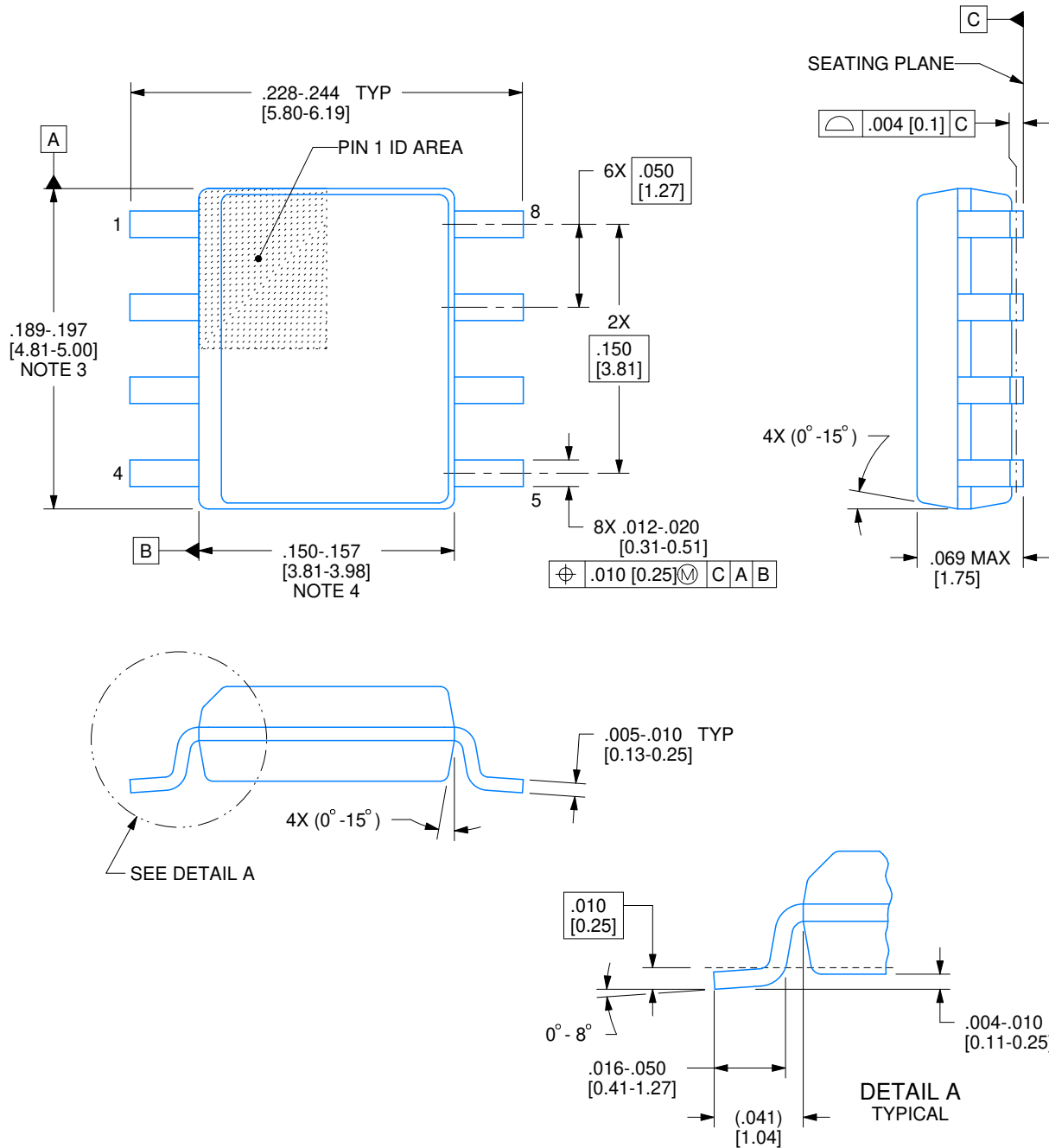
\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LM1458MX      | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| LM1458MX/NOPB | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |



**D0008A****PACKAGE OUTLINE****SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

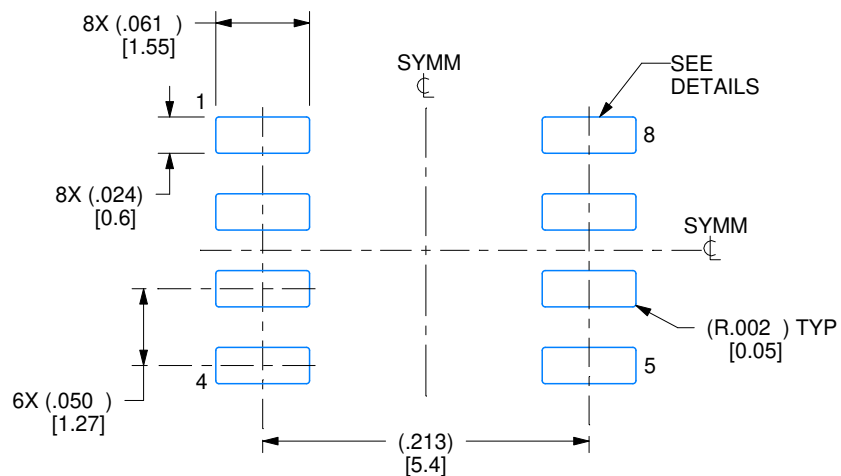
**NOTES:**

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

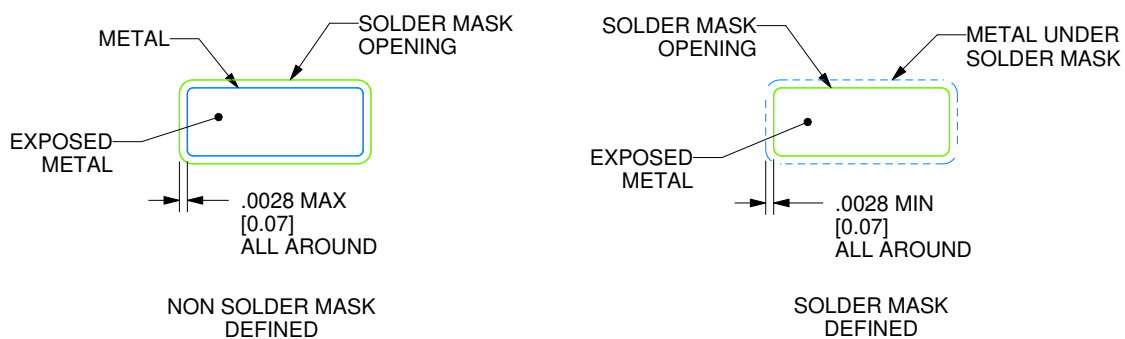
**D0008A**

### SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:8X



## SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

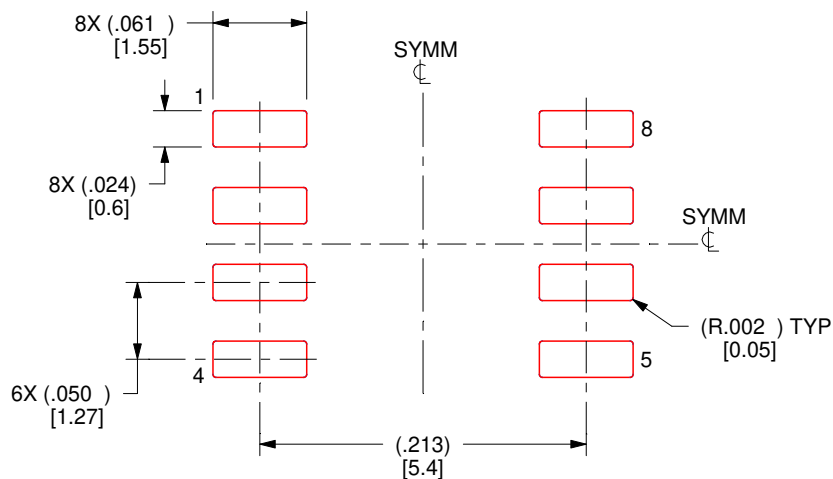
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON .005 INCH [0.125 MM] THICK STENCIL  
SCALE:8X

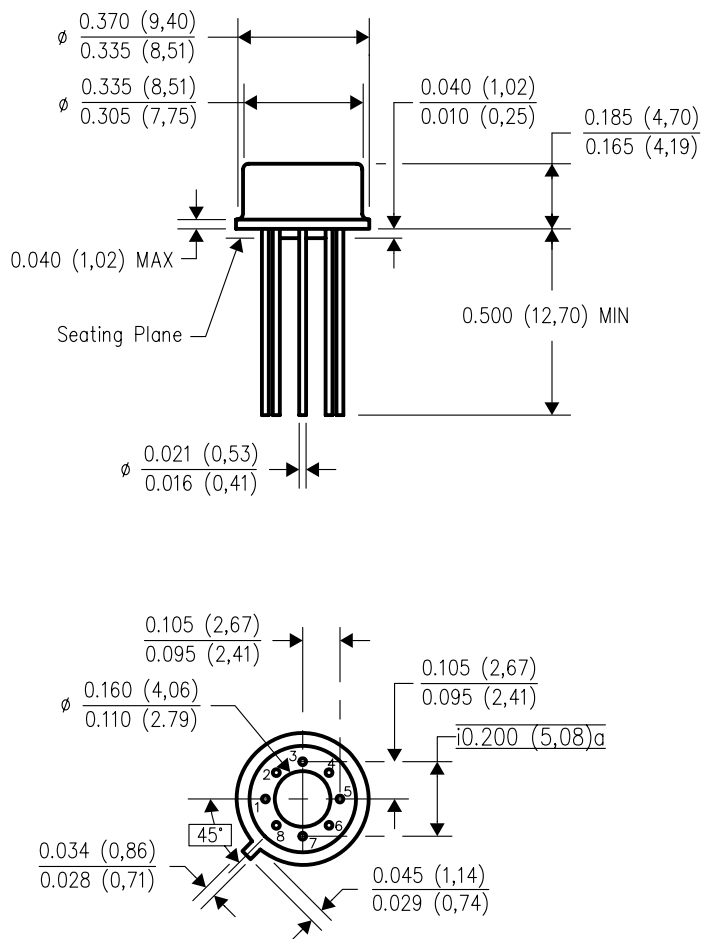
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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

## LMC (O-MBCY-W8)

## METAL CYLINDRICAL PACKAGE

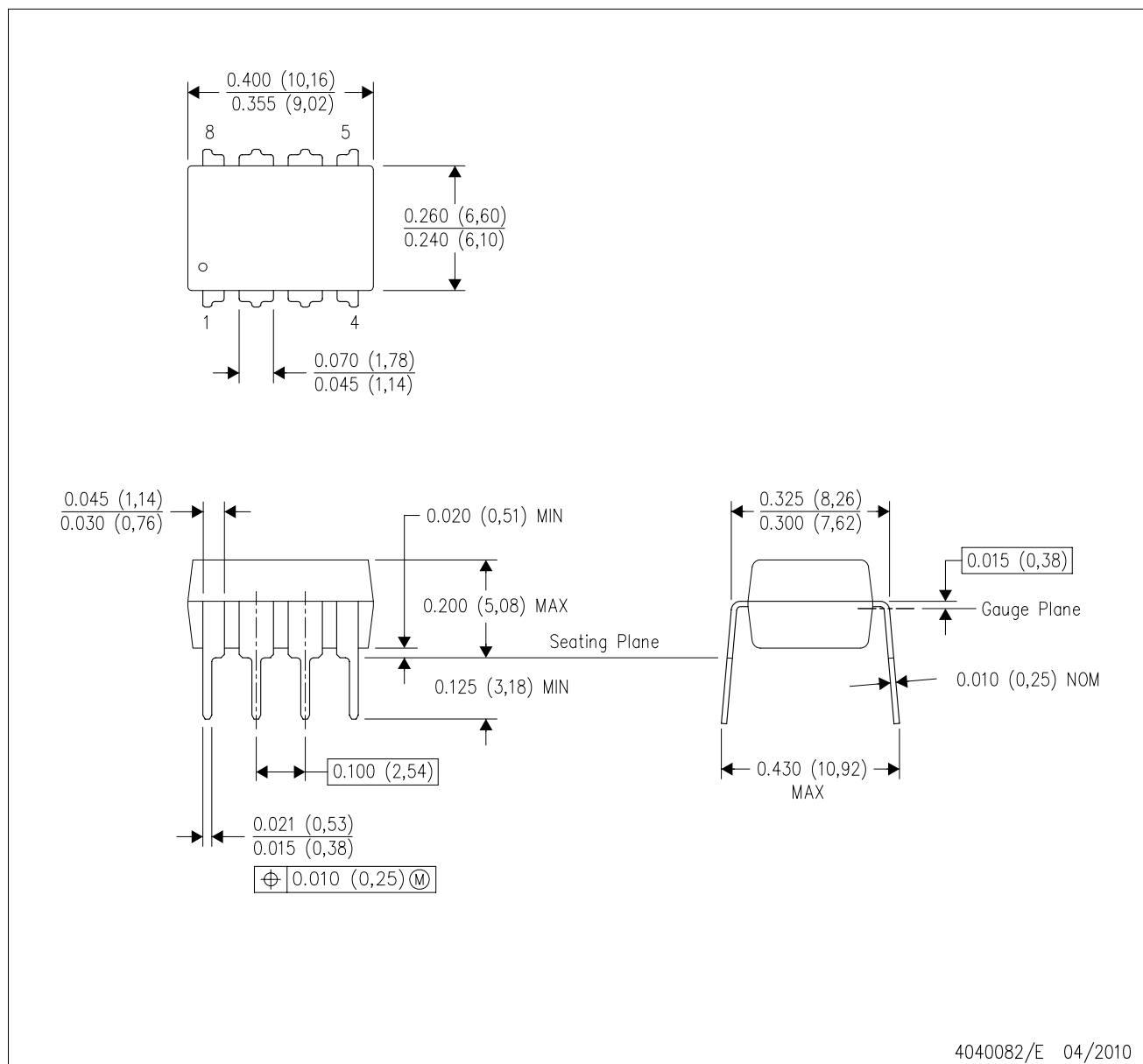


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- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - Leads in true position within 0.010 (0,25) R @ MMC at seating plane.
  - Pin numbers shown for reference only. Numbers may not be marked on package.
  - Falls within JEDEC MO-002/TO-99.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001 variation BA.

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